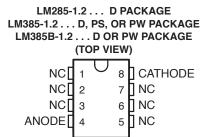
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- Operating Current Range
  - LM285 . . . 10  $\mu$ A to 20 mA
  - LM385 . . . 15  $\mu$ A to 20 mA
  - LM385B . . . 15  $\mu$ A to 20 mA
- 1% and 2% Initial Voltage Tolerance
- Reference Impedance
  - LM385 . . . 1 Ω Max at 25°C
  - All Devices . . . 1.5  $\Omega$  Max Over Full Temperature Range
- Very Low Power Consumption
- Applications
  - Portable Meter References
  - Portable Test Instruments
  - Battery-Operated Systems
  - Current-Loop Instrumentation
  - Panel Meters
- Interchangeable With Industry Standard LM285-1.2 and LM385-1.2



NC - No internal connection

LM285-1.2, LM385-1.2, LM385B-1.2... LP PACKAGE (TOP VIEW)



NC - No internal connection

## description/ordering information

These micropower, two-terminal, band-gap voltage references operate over a 10-µA to 20-mA current range and feature exceptionally low dynamic impedance and good temperature stability. On-chip trimming provides tight voltage tolerance. The band-gap reference for these devices has low noise and long-term stability.

#### **ORDERING INFORMATION**

TA	V <sub>Z</sub> TOLERANCE	PACKAG	EΤ	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
		0010 (D)	Tube of 75	LM385D-1-2	005.40		
		SOIC (D)	Reel of 2000	LM385DR-1-2	385-12		
		SOP (PS)	Reel of 2000	LM385PSR-1-2	L385-12		
	2%	TO 000 (TO 00 (LD)	Tube of 1000	LM385LP-1-2	005.40		
		TO-226 / TO-92 (LP)	Reel of 2000	LM385LPR-1-2	385-12		
0°C to 70°C		T000D (DIA)	Tube of 150	LM385PW-1-2	205 10		
		TSSOP (PW)	Reel of 2000	LM385PWR-1-2	385-12		
	1%	0010 (D)	Tube of 75	LM385BD-1-2	20ED10		
		SOIC (D)	Reel of 2000	LM385BDR-1-2	385B12		
		TO 000 (TO 00 (LD)	Tube of 1000	LM385BLP-1-2	005.40		
		TO-226 / TO-92 (LP)	Reel of 2000	LM385BLPR-1-2	385-12		
		TOOOD (DIA)	Tube of 150	LM385BPW-1-2	005040		
		TSSOP (PW)	Reel of 2000	LM385BPWR-1-2	385B12		
–40°C to 85°C	1%	2010 (5)	Tube of 75	LM285D-1-2	005.40		
		SOIC (D)	Reel of 2000	LM285DR-1-2	285-12		
		TO-226 / TO-92 (LP)	Tube of 1000	LM285LP-1-2	285-12		

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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#### description/ordering information (continued)

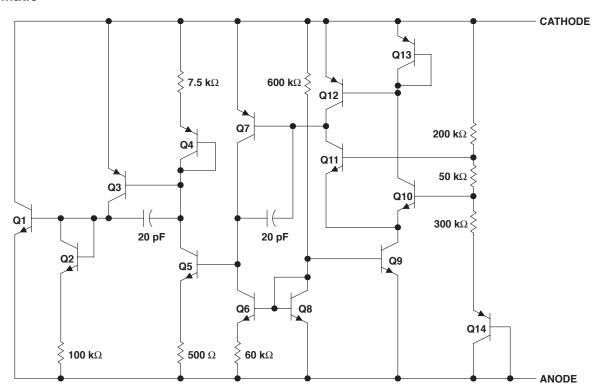
The design makes these devices exceptionally tolerant of capacitive loading and, thus, easier to use in most reference applications. The wide dynamic operating temperature range accommodates varying current supplies, with excellent regulation.

The extremely low power drain of this series makes them useful for micropower circuitry. These voltage references can be used to make portable meters, regulators, or general-purpose analog circuitry, with battery life approaching shelf life. The wide operating current range allows them to replace older references with tighter-tolerance parts.

#### symbol



#### schematic



NOTE A: Component values shown are nominal.

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Reverse current, I <sub>R</sub>		10 mA
Package thermal impedance, $\theta_{JA}$ (see Notes 1 and 2)	: D package	97°C/W
	LP package	140°C/W
	PS package	95°C/W
	PW package	149°C/W
Operating virtual junction temperature, T <sub>J</sub>		150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10	) seconds	260°C
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

			MIN	MAX	UNIT
ΙZ	Reference current		0.01	20	mA
_	One water a five a six terms and the same	LM285-1.2	-40	85	°C
TA	Operating free-air temperature range  LM385-1.2, LM385B-1.2				-0

NOTES: 1. Maximum power dissipation is a function of  $T_{J(max)}$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_{J(max)} - T_A)/\theta_{JA}$ . Operation at the absolute maximum  $T_J$  of 150°C can affect reliability.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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# electrical characteristics at specified free-air temperature

DADAMETED		TEST		LM285-1.2			LM385-1.2			LM385B-1.2				
PAF	RAMETER	CONDITIONS	T <sub>A</sub> †	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
٧Z	Reference voltage	I <sub>Z</sub> = I(min) to 20 mA <sup>‡</sup>	25°C	1.223	1.235	1.247	1.21	1.235	1.26	1.223	1.235	1.247	V	
ανΖ	Average temperature coefficient of reference voltage§	IZ = I(min) to 20 mA <sup>‡</sup>	Full range		±20			±20			±20		ppm/°C	
	Change in	$I_Z = I(min)$	25°C			1			1			1		
	reference	to 1 mA‡	Full range			1.5			1.5			1.5	,,	
$\Delta_{\Lambda}Z$	ΔVZ voltage with current	I <sub>Z</sub> = 1 mA	25°C			12			20			20	mV	
		to 20 mA	Full range			30			30			30		
ΔV <sub>Z</sub> /Δt	Long-term change in reference voltage	I <sub>Z</sub> = 100 μA	25°C		±20			±20			±20		ppm/khr	
IZ(min)	Minimum reference current		Full range		8	10		8	15		8	15	μА	
Reference impedance		$I_Z = 100  \mu A$ ,	25°C		0.2	0.6		0.4	1		0.4	1		
		f = 25 Hz	Full range			1.5			1.5			1.5	Ω	
V <sub>n</sub>	Broadband noise voltage	I <sub>Z</sub> = 100 μA, f = 10 Hz to 10 kHz	25°C		60			60			60		μV	

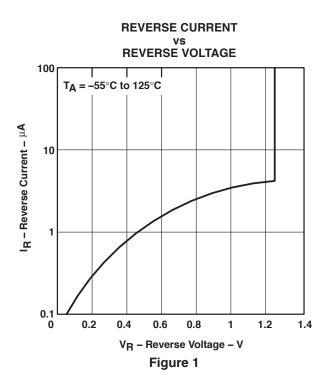
<sup>†</sup> Full range is –40°C to 85°C for the LM285-1.2 and 0°C to 70°C for the LM385-1.2 and LM385B-1.2.

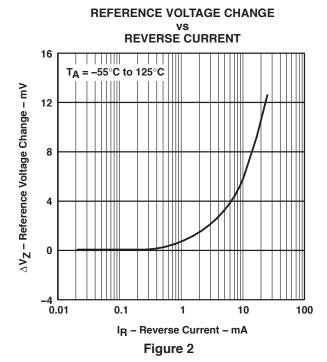
 $<sup>\</sup>ddagger$  I(min) = 10  $\mu$ A for the LM285-1.2 and 15  $\mu$ A for the LM385-1.2 and LM385B-1.2

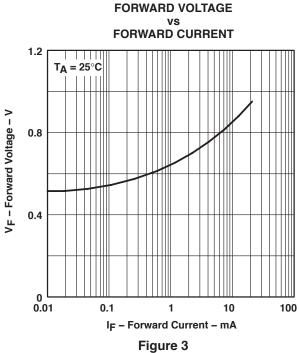
<sup>§</sup> The average temperature coefficient of reference voltage is defined as the total change in reference voltage divided by the specified temperature

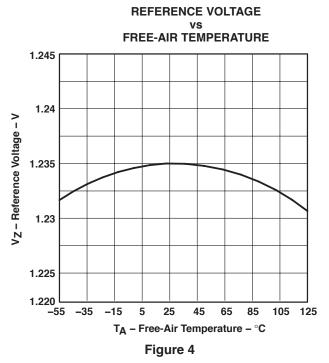
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#### TYPICAL CHARACTERISTICS†





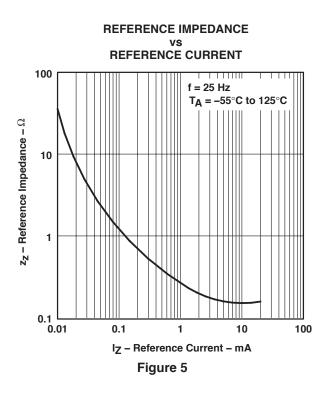


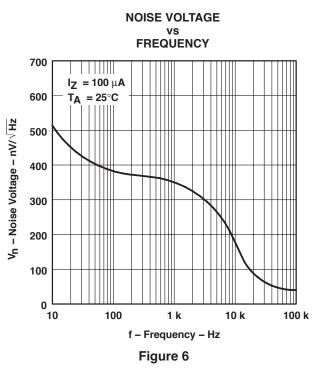


<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



#### TYPICAL CHARACTERISTICS†





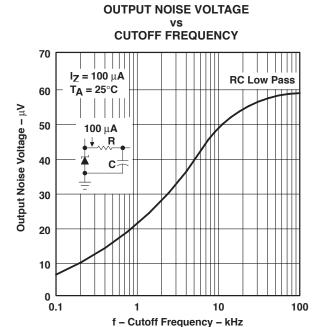
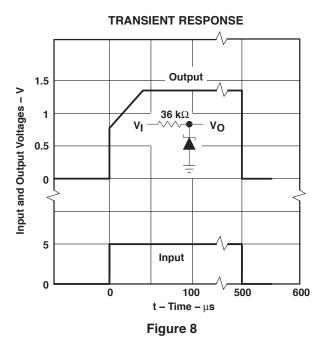


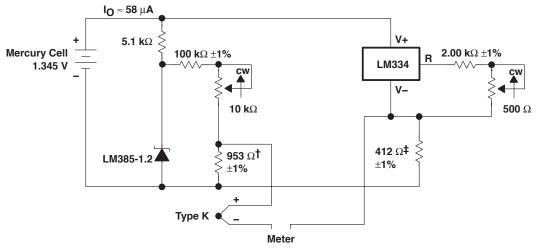
Figure 7



<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



#### **APPLICATION INFORMATION**



 $<sup>^{\</sup>dagger}$  Adjust for 11.15 mV at 25°C across 953  $\Omega$ 

Figure 9. Thermocouple Cold-Junction Compensator

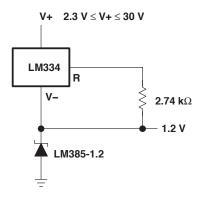


Figure 10. Operation Over a Wide Supply Range

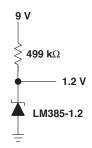


Figure 11. Reference From a 9-V Battery

 $<sup>\</sup>ddagger$  Adjust for 12.17 mV at 25°C across 412  $\Omega$ 





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#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
LM285D-1-2	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
LM285DR-1-2	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
LM285LP-1-2	ACTIVE	TO-92	LP	3	1000	None	Call TI	Level-NC-NC-NC
LM385BD-1-2	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
LM385BDR-1-2	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
LM385BLP-1-2	ACTIVE	TO-92	LP	3	1000	None	Call TI	Level-NC-NC-NC
LM385BLPR-1-2	ACTIVE	TO-92	LP	3	2000	None	Call TI	Level-NC-NC-NC
LM385BPW-1-2	ACTIVE	TSSOP	PW	8	150	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM385BPWR-1-2	ACTIVE	TSSOP	PW	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM385D-1-2	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
LM385DR-1-2	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR
LM385LP-1-2	ACTIVE	TO-92	LP	3	1000	None	Call TI	Level-NC-NC-NC
LM385LPR-1-2	ACTIVE	TO-92	LP	3	2000	None	Call TI	Level-NC-NC-NC
LM385PSR-1-2	ACTIVE	SO	PS	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM385PW-1-2	ACTIVE	TSSOP	PW	8	150	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM385PWR-1-2	ACTIVE	TSSOP	PW	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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<sup>(2)</sup> Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.



# **PACKAGE OPTION ADDENDUM**

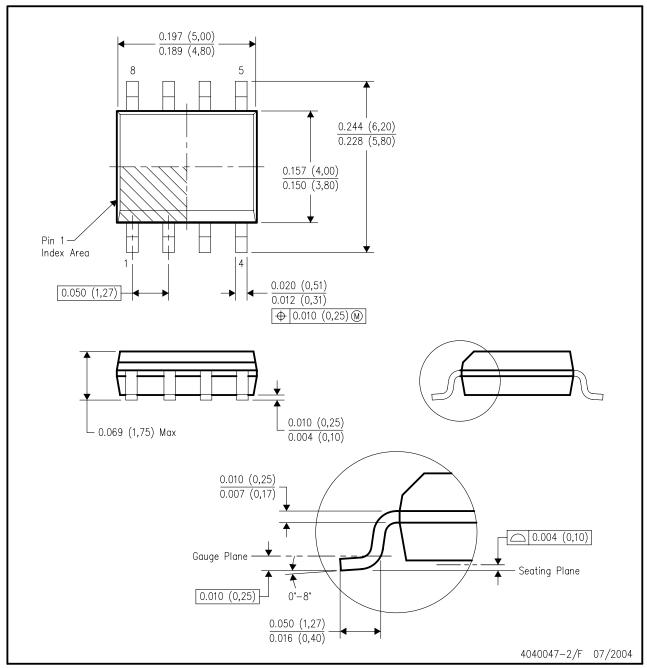
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# D (R-PDSO-G8)

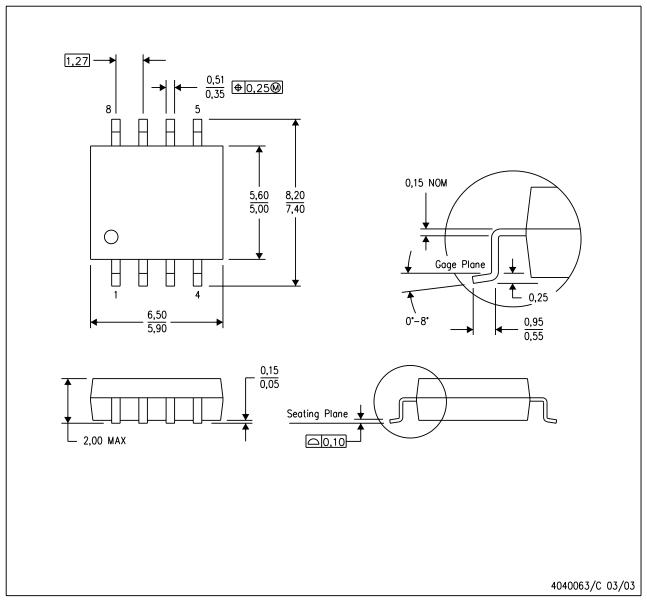
# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

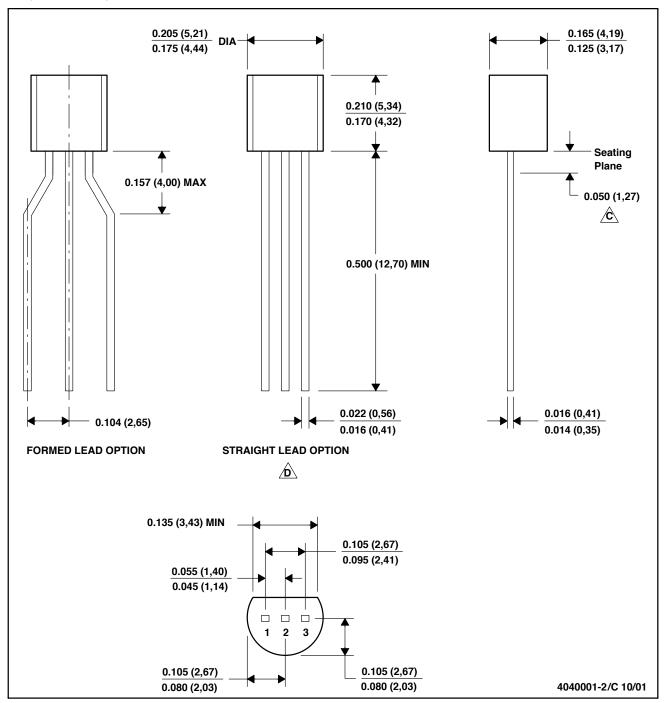
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



1

# LP (O-PBCY-W3)

#### PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

3. This drawing is subject to change without notice.

 $\underline{\lambda}$  Lead dimensions are not controlled within this area

FAlls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)

E. Shipping Method:

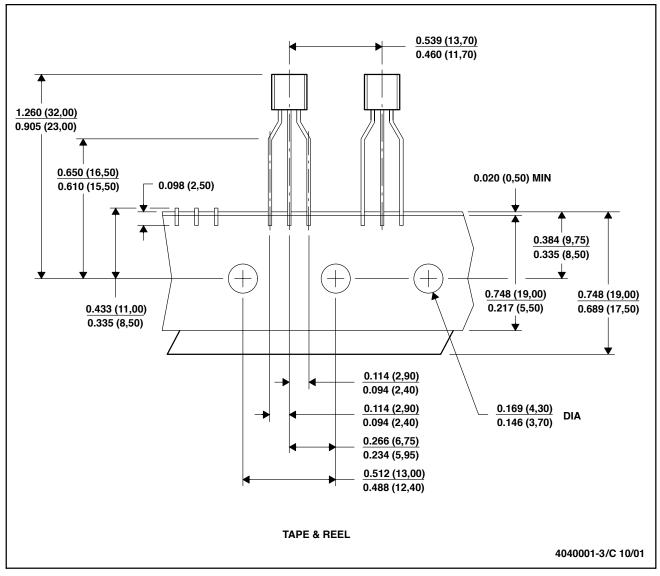
Straight lead option available in bulk pack only.

Formed lead option available in tape & reel or ammo pack.



# LP (O-PBCY-W3)

#### PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

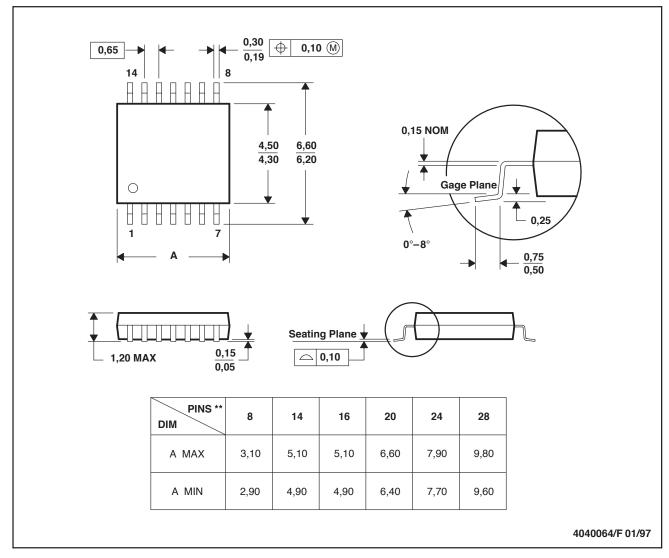
B. This drawing is subject to change without notice.

C. Tape and Reel information for the Format Lead Option package.

# PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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